



## Part 2 : Fully bonded semi conductor (non peelable)

Instructions : OUT SCNP - OUT SCP/NP - OUT SCP/NP DT - POLY SCNP

Adjustable tool for fully bonded semi conductor



OUT SCNP



OUT SCP/NP  
OUT SCP/NP DT



POLY SCNP

1



Coat the semi conductor with silicone grease

2



Screw off to unlock the blade

3



Screw off completely to put up the blade before starting the adjustment

4



Put the tool anywhere on the cable without free but with possibility to turn. Be careful to put out the blade of the opposite tool before starting the operation. (POLY SCNP, OUT SCP NP, OUT SCP NP DT)

5



Screw to put the blade in contact with the semiconductor

6



Remove the tool, and place the mark in front of you, turn the wheel direction +. Each index going past mark is 0.1mm. E.g. : for a 0.4mm adjustment, pass through 4 mark



7



Screw to lock the adjustment

8



To start, put the end of the cable in front of the red mark and block the tool

9



Lock the adjustment thanks to the locking nut

10



Start to machine the semiconductor, turning clockwise. The handle pressure permits to get a width band of semiconductor more or less important. To get the best result, turn smoothly and obtain a width band of 3mm. (approx. 2/3 black, 1/3 white)

11



Machine the semiconductor. Possibility to use the integrated scale gauge which permits to get various length of remaining semiconductor : 30 (scale gauge inside), 40-45-55mm (OUT SCP NP DT), 25 (scale gauge inside) 30-35-40-45-50-55mm (OUT SCNP - OUT SCP NP)

12



Once at the end, finish with an ultimate turn. The semiconductor band breaks itself, leaving a chamfer on the remaining part. Remove the tool